LB1945D

Recommended Operating Range at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Motor supply voltage	V _{BB}		10 to 28	V
Logic system supply voltage	V _{CC}		4.75 to 5.25	V
Reference voltage	VREF		1.5 to 5.0	V

Electrical Characteristics at Ta = 25°C, V_{BB} = 24V, V_{CC} = 5V, VREF = 5V

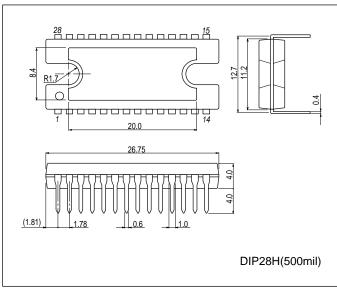
Parameter	Symbol	Conditions		Ratings			
Parameter	Symbol	Conditions	min	typ	max	Unit	
Output block							
Output stage supply current	I _{BB} ON	I ₁ = 0.8V, I ₂ = 0.8V, ENABLE = 0.8V	0.5	1.0	2.0	mA	
	I _{BB} OFF	ENABLE = 3.2V			0.2		
Output saturation voltage 1	V _O sat1	I _O = +0.5A, sink side		0.3	0.5	V	
Output saturation voltage 2	V _O sat2	I _O = +0.8A, sink side		0.5	0.7	V	
Output saturation voltage 3	V _O sat3	I _O = -0.5A, source side		1.6	1.8	V	
Output saturation voltage 4	V _O sat4	I _O = -0.8A, source side		1.8	2.0	V	
Output leakage current	V _O 1(leak) V _O 2(leak)	$V_{O} = V_{BB}$, sink side $V_{O} = 0V$, source side	-50		50	μΑ	
Output sustain voltage	VSUS	L = 3.9mH, I _O = 1.0A*	30			V	
Logic block							
Logic supply current	I _{CC} ON	I ₁ = 0.8V, I ₂ = 0.8V, ENABLE = 0.8V	50	70.0	92	mA	
	I _{CC} OFF	ENABLE = 3.2V	7	10.0	13		
Input voltage	VIH		3.2			V	
	V_{IL}				1.8	v	
Input current	Чн	V _{IH} = 3.2V	35	50	65	μA	
	١ _{١L}	$V_{IL} = 0.8V$	7	10	13	μΑ	
Set current control threshold	VREF/	$I_1 = 0.8V, I_2 = 0.8V$	9.5	10	10.5		
value	VSEN	I ₁ = 3.2V, I ₂ = 0.8V	13.5	15	16.5		
		I ₁ = 0.8V, I ₂ = 3.2V	25.5	30	34.5		
Reference current	IREF	VREF = 5.0V, I ₁ = 0.8V, I ₂ = 0.8V	17.5	25	32.5	μΑ	
CR pin current	ICR	CR = 1.0V	-1.0			μΑ	
Thermal shutdown temperature	TS			170		°C	
Thermal shutdown hysteresis	TSHY			40		°C	

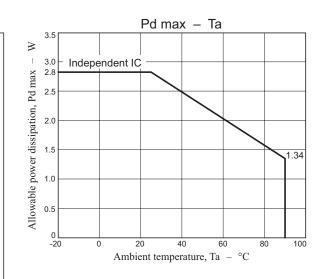
*: The design specification items are design guarantees and are not measured.

Package Dimensions

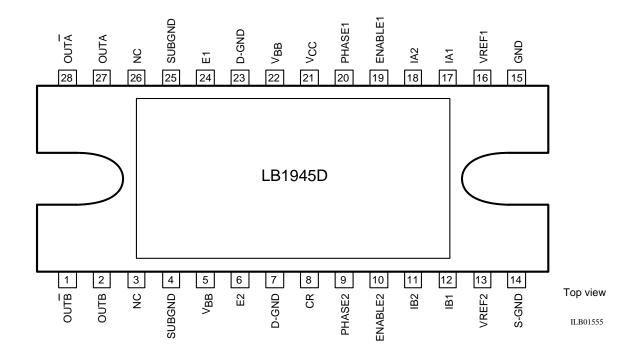
unit:mm (typ)

3147C



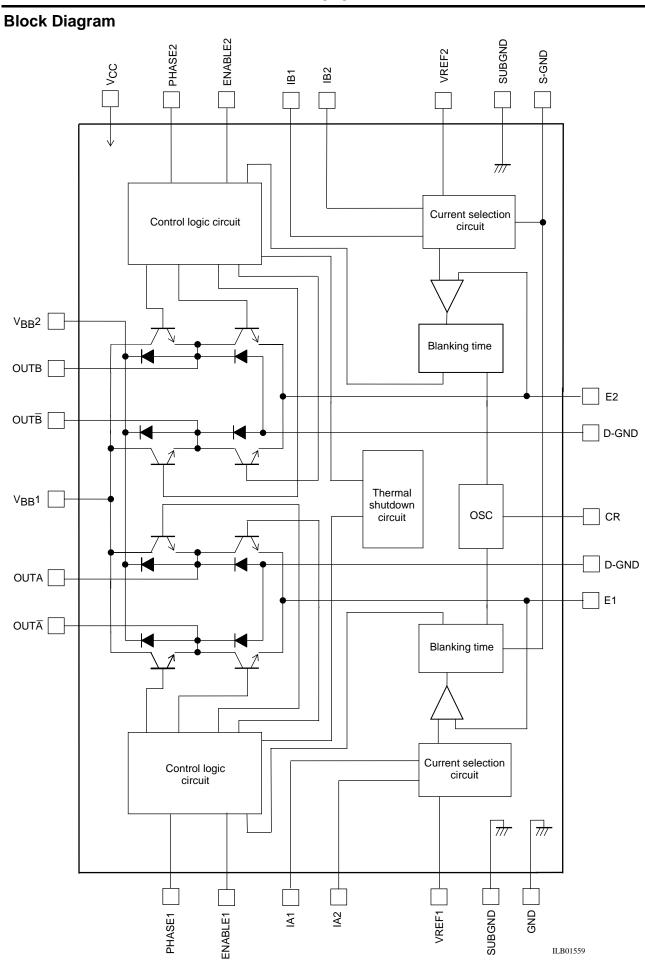


Pin Assignment

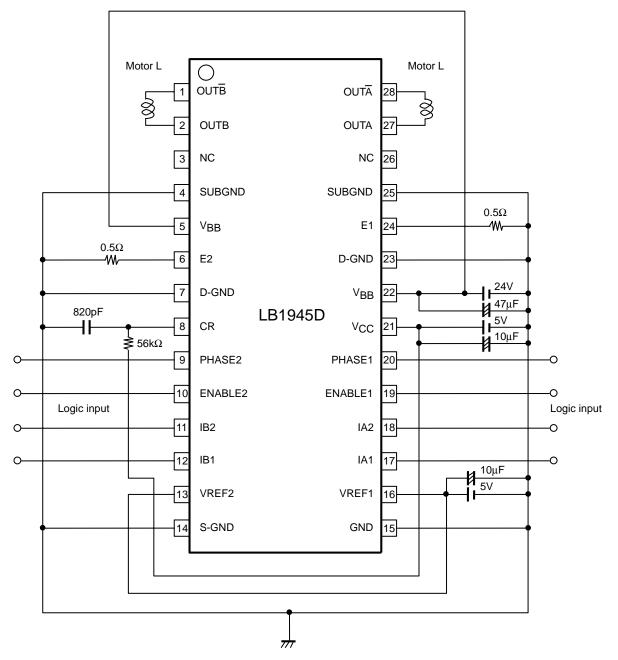


Pin Functions

Pin No.	Pin	Description
22	V _{BB} 1	Output stage power supply voltage
5	V _{BB} 2	High side diode cathode connection
24	E1	The set current is controlled by inserting resistors RE between these pins and ground.
6	E2	
27	OUTA	Output pins
28	OUTĀ	
2	OUTB	
1	OUTB	
15	GND	Ground
14	S-GND	Sense ground
4, 25	SUBGND	IC sub-ground
23	D-GND	Low side built-in diode ground (anode side)
7		
8	CR	Chopping is performed at the period of a triangle wave set by the RC circuit connected to this pin.
		The triangle wave off time is the noise cancellation time.
16	VREF1	Output current settings.
13	VREF2	(The output current is determined by providing an input in the range 1.5V to 5V.)
20	PHASE1	Output phase switching inputs
9	PHASE2	High-level input: $OUTA = high, OUTA = low$
		Low-level input: $OUTA = Iow, OUT\overline{A} = high$
19	ENABLE1	Output on/off control inputs
10	ENABLE2	High-level input: Output off
		Low-level input: Output on
17, 18	IA1, IA2	Output current setting digital inputs.
12, 11	IB1, IB2	The output current is set to 1/3, 2/3 or 1 by input high/low levels to these pins.
21	VCC	Logic block power supply voltage



Application circuit



ILB01556

Truth Table

ENABLE	PHASE	OUTA	OUTA
Low	High	High	Low
Low	Low	Low	High
High	-	OFF	OFF

l ₁	l ₂	Output current
Low	Low	$Vref/(10 \times R_E) = I_{OUT}$
High	Low	$Vref/(15 \times R_E) = I_{OUT} \times 2/3$
Low	High	$Vref/(30 \times R_E) = I_{OUT} \times 1/3$
High	High	0

Note: The output is turned off when ENABLE is high or in the $I_1 = I_2$ = high state.

Clockwise/counterclockwise Operating Sequence

2-phase excitation drive

Clockwise ro	tation				IA1 = I	A2 = IB1 = IB2 = 0
No.	PHASE1	OUTA	OUTA	PHASE2	OUTB	OUTB
0	0	0	1	0	0	1
1	1	1	0	0	0	1
2	1	1	0	1	1	0
3	0	0	1	1	1	0

C	Counterclockwise rotation IA1 = IA2 = IB1 = IB2 = 0							
	No.	PHASE1	OUTA	OUTA	PHASE2	OUTB	OUTB	
	0	0	0	1	1	1	0	
	1	1	1	0	1	1	0	
	2	1	1	0	0	0	1	
	3	0	0	1	0	0	1	

Control Sequence

2-phase excitation

				Table 1			ENAB	LE1 = ENABLE2 = 0	
NO	Phase A					Phase B			
NO	PH1	IA2	IA1	Current value	PH2	IB2	IB1	Current value	
0	0	0	0	1	0	0	0	1	
1	1	0	0	1	0	0	0	1	
2	1	0	0	1	1	0	0	1	
3	0	0	0	1	1	0	0	1	

1-2 phase excitation - 1/2 step

_	Table 2						ENA	BLE1 = ENABLE2 = 0	
Ne						Phase B			
No.	PH1	IA2	IA1	Current value	PH2	IB2	IB1	Current value	
0	0	0	0	1	*	1	1	0	
1	0	0	1	2/3	0	0	1	2/3	
2	*	1	1	0	0	0	0	1	
3	1	0	1	2/3	0	0	1	2/3	
4	1	0	0	1	*	1	1	0	
5	1	0	1	2/3	1	0	1	2/3	
6	*	1	1	0	1	0	0	1	
7	0	0	1	2/3	1	0	1	2/3	

1-2 phase Excitation Timing Chart

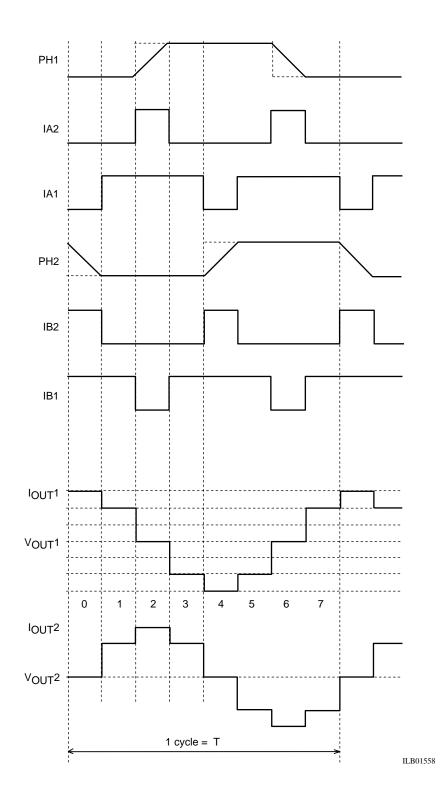
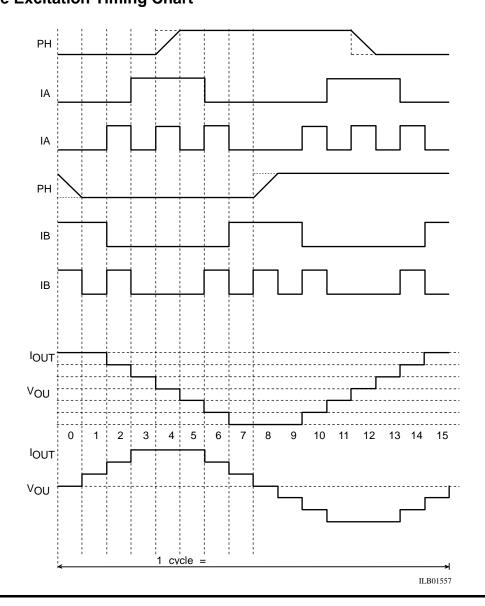


				Table 3			ENAB	LE1 = ENABLE2
			Phase A				Phase B	
NO	PH1	IA2	IA1	Current value	PH2	IB2	IB1	Current value
0	0	0	0	1	*	1	1	0
1	0	0	0	1	0	1	0	1/3
2	0	0	1	2/3	0	0	1	2/3
3	0	1	0	1/3	0	0	0	1
4	*	1	1	0	0	0	0	1
5	1	1	0	1/3	0	0	0	1
6	1	0	1	2/3	0	0	1	2/3
7	1	0	0	1	0	1	0	1/3
8	1	0	0	1	*	1	1	0
9	1	0	0	1	1	1	0	1/3
10	1	0	1	2/3	1	0	1	2/3
11	1	1	0	1/3	1	0	0	1
12	*	1	1	0	1	0	0	1
13	0	1	0	1/3	1	0	0	1
14	0	0	1	2/3	1	0	1	2/3
15	0	0	0	1	1	1	0	1/3

W1-2 phase Excitation Timing Chart



LB1945D

Simplified Equations for Determining RC Component Values

The equations for setting the RC oscillator circuit rise time (T1) and fall time (T2) are shown below.

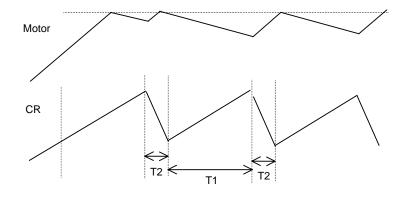
T1 \approx 0.44C \times R (s)

 $T2 \approx 0.72 \times (C \times R \times 1000)/(R + 1000)$ (s)

(C:220 to 4700pF, R = 10 to $150k\Omega$)

The oscillator frequency must be set using the simplified equations shown above.

Note that the triangle wave fall time (T2) is also used as the noise canceller time.



Usage Notes

1. VREF

Since the VREF pin is the input pin for the reference voltage that sets the current, applications must be designed so that noise does not appear on this pin.

2. Ground pins

Since this IC switches high currents, the following points concerning grounding must be observed.

- The fins on the package rear surface, pins 7 and 8, and pins 21 and 22 must all be grounded.
- Sections of the circuit that carry large currents must be implemented with wide lines in the printed circuit pattern, and must be physically separated from the small signal system.
- The E pin sense resistor (RE) must be position as close as possible to the IC ground (pin 14).
- The capacitors between V_{CC} and ground and between V_{BB} and ground must be positioned as close as possible to the V_{CC} and V_{BB} pins on the printed circuit pattern.

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